TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type ( $L^2$ - $\pi$ -MOSV)

## 2SK2782

# Chopper Regulator, DC/DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain-source ON-resistance  $: RDS(ON) = 0.039 \Omega \text{ (typ.)}$ 

• High forward transfer admittance  $: |Y_{fs}| = 11 \text{ S (typ.)}$ 

• Low leakage current  $: IDSS = 100 \mu A \text{ (max) (VDS} = 60 \text{ V)}$ 

• Enhancement mode :  $V_{th} = 0.8 \sim 2.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$ 

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	60	V	
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		$V_{DGR}$	60	V	
Gate-source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC (Note 1)	ΙD	20	Α	
	Pulse (Note 1)	$I_{DP}$	50	Α	
Drain power dissipation (Tc = 25°C)		P <sub>D</sub>	40	W	
Single-pulse avalanche energy (Note 2)		E <sub>AS</sub>	156	mJ	
Avalanche current		I <sub>AR</sub>	20	Α	
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	4	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

#### **Thermal Characteristics**

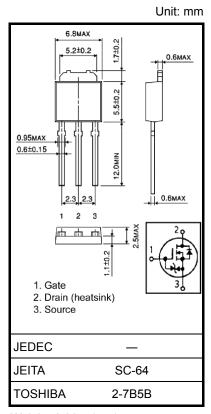
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	3.125	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

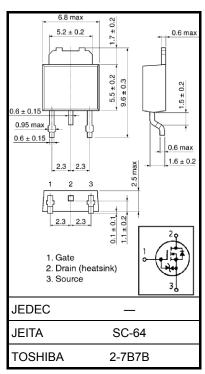
Note 2:  $V_{DD} = 25 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial),  $L = 530 \mu\text{H}$ ,  $R_G = 25 \Omega$ ,  $I_D = 20 \text{ A}$ 

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



Weight: 0.36 g (typ.)



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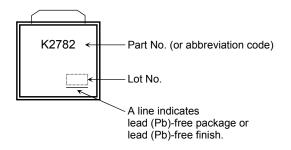
## **Electrical Characteristics (Ta = 25°C)**

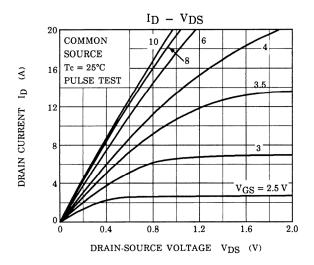
Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cu	ırrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ	
Drain cutoff curr	ent	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V	_	_	100	μΑ	
Drain-source bi	reakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	60	_	_	V	
Gate threshold	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	8.0	_	2.0	V	
Drain-source ON-resistance		R <sub>DS (ON)</sub>	V <sub>DS</sub> = 4 V, I <sub>D</sub> = 5 A	_	0.06	0.09	Ω	
			V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A	_	0.039	0.055	72	
Forward transfe	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A	7	11	_	S	
Input capacitano	ce	C <sub>iss</sub>		_	880	_		
Reverse transfe	r capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	90	_	pF	
Output capacitance		Coss		_	330	_		
Switching time	Rise time	t <sub>r</sub>	$V_{GS}$ $0V$ $R_{L}=3.0\Omega$ $V_{DD}=30V$	_	15	_		
	Turn-on time	t <sub>on</sub>		_	25	_	no	
	Fall time	t <sub>f</sub>		_	30	_	ns	
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_{\rm W} = 10 \mu \rm s$	_	100	_		
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		25		_	
Gate-source charge		Q <sub>gs</sub>			19	_	nC	
Gate-drain ("Miller") charge		Q <sub>gd</sub>			6	_		

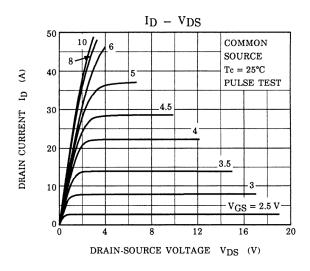
## Source-Drain Ratings and Characteristics (Ta = 25°C)

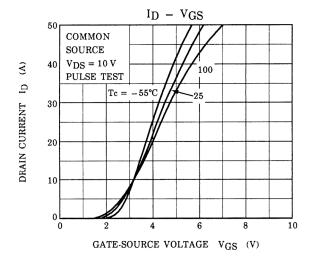
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	20	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	50	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 20 A, V <sub>GS</sub> = 0 V	_	_	-2.0	V
Reverse recovery time	t <sub>rr</sub>	$I_{DR}$ = 20 A, $V_{GS}$ = 0 V, $dI_{DR}$ / $dt$ = 50 A / $\mu$ s		60		ns
Reverse recovery charge	Q <sub>rr</sub>		ı	45	_	μC

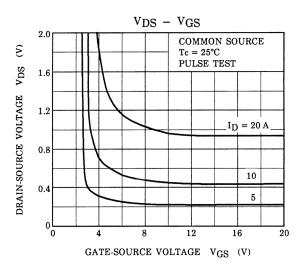
## Marking

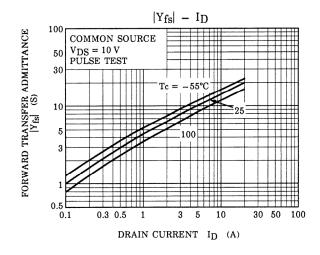


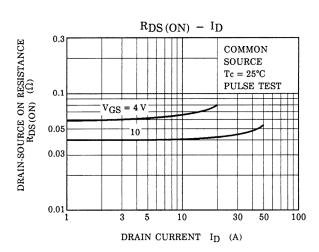


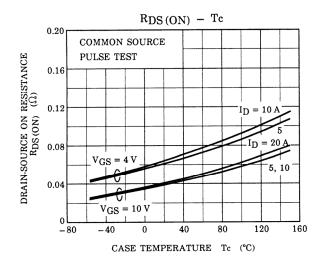


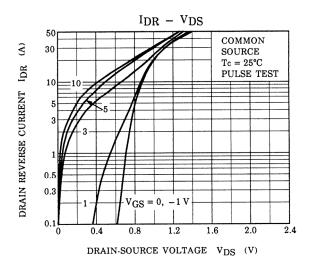


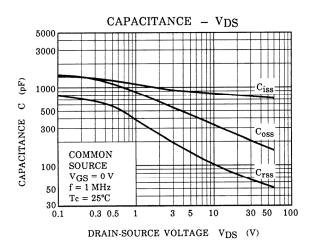


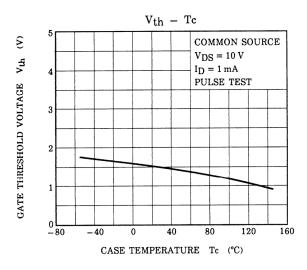


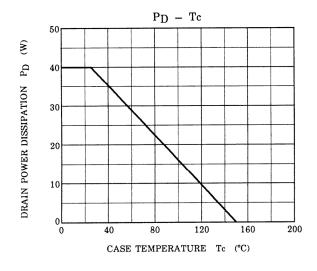


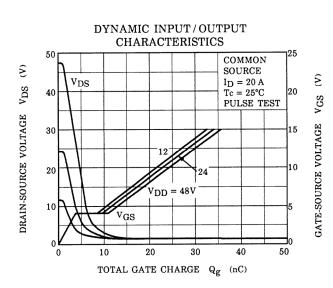


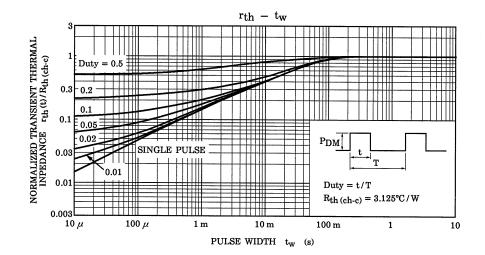


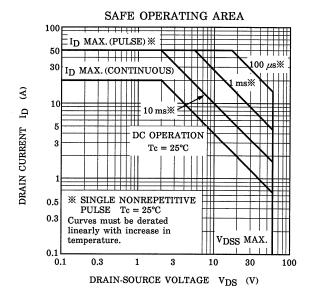


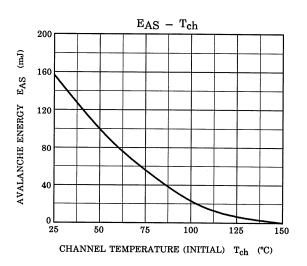


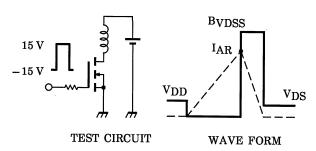












$$R_G$$
 = 25  $\Omega$   $V_{DD}$  = 25 V, L = 530  $\mu H$ 

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$$EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{BVDSS}{BVDSS - VDD} \right)$$

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